## MC74VHC245

## Octal Bus Buffer/Line Driver

The MC74VHC245 is an advanced high speed CMOS octal bus transceiver fabricated with silicon gate CMOS technology. It achieves high speed operation similar to equivalent Bipolar Schottky TTL while maintaining CMOS low power dissipation.

It is intended for two-way asynchronous communication between data buses. The direction of data transmission is determined by the level of the DIR input. The output enable pin ( $\overline{\mathrm{OE}})$ can be used to disable the device, so that the buses are effectively isolated.

All inputs are equipped with protection circuits against static discharge.

- High Speed: $\mathrm{t}_{\mathrm{PD}}=4.0 \mathrm{~ns}$ (Typ) at $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$
- Low Power Dissipation: $\mathrm{I}_{\mathrm{CC}}=4 \mu \mathrm{~A}$ (Max) at $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$
- High Noise Immunity: $\mathrm{V}_{\mathrm{NIH}}=\mathrm{V}_{\mathrm{NIL}}=28 \% \mathrm{~V}_{\mathrm{CC}}$
- Power Down Protection Provided on Inputs
- Balanced Propagation Delays
- Designed for 2 V to 5.5 V Operating Range
- Low Noise: $\mathrm{V}_{\text {OLP }}=1.2 \mathrm{~V}$ (Max)
- Pin and Function Compatible with Other Standard Logic Families
- Latchup Performance Exceeds 300 mA
- ESD Performance: HBM > 2000 V; Machine Model > 200 V
- Chip Complexity: 308 FETs or 77 Equivalent Gates
- These Devices are $\mathrm{Pb}-$ Free and are RoHS Compliant


## APPLICATION NOTES

- Do not force a signal on an I/O pin when it is an active output, damage may occur.
- All floating (high impedance) input or I/O pins must be fixed by means of pull up or pull down resistors or bus terminator ICs.
- A parasitic diode is formed between the bus and $\mathrm{V}_{\mathrm{CC}}$ terminals. Therefore, the VHC245 cannot be used to interface 5 V to 3 V systems directly.

ON Semiconductor ${ }^{\text {m }}$
http://onsemi.com


| VHC245 | $=$ Specific Device Code |
| :--- | :--- |
| A | $=$ Assembly Location |
| WL, L | $=$ Wafer Lot |
| Y | $=$ Year |
| WW, W | $=$ Work Week |
| G or : | $=$ Pb-Free Package |

(Note: Microdot may be in either location)

## ORDERING INFORMATION

| Device | Package | Shipping ${ }^{\dagger}$ |
| :--- | :---: | :---: |
| MC74VHC245DWG | SOIC-20 | 38 Units/Rail |
| MC74VHC245DTG | TSSOP-20 | 75 Units/Rail |
| MC74VHC245DWR2G | SOIC-20 | 1000 Units/Reel |
| MC74VHC245DTR2G | TSSOP-20 | 2500 Units/T\&R |

$\dagger$ For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

## MC74VHC245



Figure 1. LOGIC DIAGRAM

| DIR $[$ | $1 \bullet$ | 20 | ] $\mathrm{V}_{\mathrm{CC}}$ |
| :---: | :---: | :---: | :---: |
| A1 | 2 | 19 | ] $\overline{\mathrm{OE}}$ |
| A2 | 3 | 18 | B1 |
| A3 | 4 | 17 | B2 |
| A4 | 5 | 16 | B3 |
| A5 | 6 | 15 | ] ${ }^{\text {4 }}$ |
| A6 | 7 | 14 | B5 |
| A7 [ | 8 | 13 | B6 |
| A8 | 9 | 12 | B7 |
| GND [ | 10 | 11 | B8 |

Figure 2. PIN ASSIGNMENT

| FUNCTION TABLE |  |  |
| :---: | :---: | :--- |
| Control Inputs |  | Operation |
| $\overline{\mathrm{OE}}$ | DIR |  |
| L | L | Data Transmitted from Bus B to Bus A |
| L | H | Data Transmitted from Bus A to Bus B |
| H | X | Buses Isolated (High-Impedance State) |

MAXIMUM RATINGS*

| Symbol | Parameter | Value | Unit |
| :---: | :--- | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | DC Supply Voltage | -0.5 to +7.0 | V |
| $\mathrm{~V}_{\text {in }}$ | DC Input Voltage | -0.5 to +7.0 | V |
| $\mathrm{~V}_{\text {out }}$ | DC Output Voltage | -0.5 to $\mathrm{V}_{\mathrm{CC}}+0.5$ | V |
| $\mathrm{I}_{\mathrm{IK}}$ | Input Diode Current | -20 | mA |
| $\mathrm{I}_{\mathrm{OK}}$ | Output Diode Current | $\pm 20$ | mA |
| $\mathrm{I}_{\text {out }}$ | DC Output Current, per Pin | $\pm 25$ | mA |
| $\mathrm{I}_{\mathrm{CC}}$ | DC Supply Current, $\mathrm{V}_{\mathrm{CC}}$ and GND Pins | $\pm 75$ | mA |
| $\mathrm{P}_{\mathrm{D}}$ | Power Dissipation in Still Air $\quad$ SOIC Packages $\dagger$ | 500 | mW |
|  |  | 450 |  |
| $\mathrm{~T}_{\text {stg }}$ | Storage Temperature | -65 to +150 | ${ }^{\circ} \mathrm{C}$ |

* Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.
†Derating - SOIC Packages: $-7 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ from $65^{\circ}$ to $125^{\circ} \mathrm{C}$
TSSOP Package: $-6.1 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$ from $65^{\circ}$ to $125^{\circ} \mathrm{C}$


## RECOMMENDED OPERATING CONDITIONS

| Symbol | Parameter |  | Min | Max | Unit |
| :---: | :--- | :---: | :---: | :---: | :---: |
| $\mathrm{V}_{\mathrm{CC}}$ | DC Supply Voltage | 2.0 | 5.5 | V |  |
| $\mathrm{~V}_{\text {in }}$ | DC Input Voltage | 0 | 5.5 | V |  |
| $\mathrm{~V}_{\text {out }}$ | DC Output Voltage |  | 0 | $\mathrm{~V}_{\mathrm{CC}}$ | V |
| $\mathrm{T}_{\mathrm{A}}$ | Operating Temperature |  | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |
| $\mathrm{t}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$ | Input Rise and Fall Time | $\mathrm{V}_{\mathrm{CC}}=3.3 \mathrm{~V} \pm 0.3 \mathrm{~V}$ | 0 | 100 | $\mathrm{~ns} / \mathrm{V}$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V} \pm 0.5 \mathrm{~V}$ | 0 | 20 |  |

## DC ELECTRICAL CHARACTERISTICS

| Symbol | Parameter | Test Conditions | $\stackrel{\mathrm{v}_{\mathrm{cc}}}{\mathrm{~V}}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | $\mathrm{T}_{\mathrm{A}}=-40$ to $85^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Max |  |
| $\mathrm{V}_{\mathrm{IH}}$ | Minimum High-Level Input Voltage |  | $\begin{gathered} 2.0 \\ 3.0 \text { to } \\ 5.5 \end{gathered}$ | $\begin{gathered} 1.50 \\ v_{C C} \times 0.7 \end{gathered}$ |  |  | $\begin{gathered} 1.50 \\ v_{C C} \times 0.7 \end{gathered}$ |  | V |
| $\mathrm{V}_{\text {IL }}$ | Maximum Low-Level Input Voltage |  | $\begin{gathered} 2.0 \\ 3.0 \text { to } \\ 5.5 \end{gathered}$ |  |  | $\begin{gathered} 0.50 \\ \mathrm{v}_{\mathrm{CC}} \times 0.3 \end{gathered}$ |  | $\begin{gathered} 0.50 \\ V_{C C} \times 0.3 \end{gathered}$ | V |
| $\mathrm{V}_{\mathrm{OH}}$ | Minimum High-Level Output Voltage | $\begin{aligned} & \mathrm{V}_{\mathrm{in}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} \\ & \mathrm{IOH}^{2}=-50 \mu \mathrm{~A} \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \end{aligned}$ | $\begin{aligned} & 1.9 \\ & 2.9 \\ & 4.4 \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \end{aligned}$ |  | $\begin{aligned} & 1.9 \\ & 2.9 \\ & 4.4 \end{aligned}$ |  | V |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{in}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} \\ & \mathrm{I}_{\mathrm{OH}}=-4 \mathrm{~mA} \\ & \mathrm{I}_{\mathrm{OH}}=-8 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 4.5 \end{aligned}$ | $\begin{aligned} & 2.58 \\ & 3.94 \end{aligned}$ |  |  | $\begin{aligned} & 2.48 \\ & 3.80 \end{aligned}$ |  |  |
| $\mathrm{V}_{\text {OL }}$ | Maximum Low-Level Output Voltage | $\begin{aligned} & \mathrm{V}_{\text {in }}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} \\ & \mathrm{IOL}^{\mathrm{OL}}=50 \mu \mathrm{~A} \end{aligned}$ | $\begin{aligned} & 2.0 \\ & 3.0 \\ & 4.5 \end{aligned}$ |  | $\begin{aligned} & \hline 0.0 \\ & 0.0 \\ & 0.0 \end{aligned}$ | $\begin{aligned} & \hline 0.1 \\ & 0.1 \\ & 0.1 \end{aligned}$ |  | $\begin{aligned} & \hline 0.1 \\ & 0.1 \\ & 0.1 \end{aligned}$ | V |
|  |  | $\begin{aligned} \mathrm{V}_{\mathrm{in}}=\mathrm{V}_{\mathrm{IH}} \text { or } \mathrm{V}_{\mathrm{IL}} & \\ \mathrm{I}_{\mathrm{OL}} & =4 \mathrm{~mA} \\ \mathrm{I}_{\mathrm{OL}} & =8 \mathrm{~mA} \end{aligned}$ | $\begin{aligned} & 3.0 \\ & 4.5 \end{aligned}$ |  |  | $\begin{aligned} & 0.36 \\ & 0.36 \end{aligned}$ |  | $\begin{aligned} & 0.44 \\ & 0.44 \end{aligned}$ |  |
| $\mathrm{l}_{\text {in }}$ | Maximum Input Leakage Current | $\begin{aligned} & \mathrm{V}_{\text {in }}=5.5 \mathrm{~V} \text { or GND } \\ & \text { (DIR, } \overline{O E} \text { ) } \end{aligned}$ | 0 to 5.5 |  |  | $\pm 0.1$ |  | $\pm 1.0$ | $\mu \mathrm{A}$ |

DC ELECTRICAL CHARACTERISTICS

| Symbol | Parameter | Test Conditions | $\underset{\mathbf{V}}{\mathbf{v}_{\mathrm{cc}}}$ | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | $\mathrm{T}_{\mathrm{A}}=-40$ to $85^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Max |  |
| loz | Maximum <br> Three-State Leakage Current | $\begin{aligned} & \mathrm{V}_{\text {in }}=\mathrm{V}_{\mathrm{IL}} \text { or } \mathrm{V}_{\text {IH }} \\ & \mathrm{V}_{\text {out }}=\mathrm{V}_{\mathrm{CC}} \text { or } G N D \end{aligned}$ | 5.5 |  |  | $\pm 0.25$ |  | $\pm 2.5$ | $\mu \mathrm{A}$ |
| Icc | Maximum Quiescent Supply Current | $\mathrm{V}_{\text {in }}=\mathrm{V}_{\text {cc }}$ or GND | 5.5 |  |  | 4.0 |  | 40.0 | $\mu \mathrm{A}$ |

AC ELECTRICAL CHARACTERISTICS (Input $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=3.0 \mathrm{~ns}$ )

| Symbol | Parameter | Test Conditions |  | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  |  | $\mathrm{T}_{\mathrm{A}}=-40$ to $85^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Typ | Max | Min | Max |  |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{PLH}}, \\ & \mathrm{t}_{\mathrm{PHL}} \end{aligned}$ | Maximum Propagation Delay, $A$ to $B$ or $B$ to $A$ | $\mathrm{V}_{C C}=3.3 \pm 0.3 \mathrm{~V}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} \end{aligned}$ |  | $\begin{aligned} & 5.8 \\ & 8.3 \end{aligned}$ | $\begin{gathered} \hline 8.4 \\ 11.9 \end{gathered}$ | $\begin{aligned} & 1.0 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & 10.0 \\ & 13.5 \end{aligned}$ | ns |
|  |  | $\mathrm{V}_{\mathrm{CC}}=5.0 \pm 0.5 \mathrm{~V}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} \end{aligned}$ |  | $\begin{aligned} & 4.0 \\ & 5.5 \end{aligned}$ | $\begin{aligned} & 5.5 \\ & 7.5 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & 6.5 \\ & 8.5 \end{aligned}$ |  |
| $\begin{aligned} & \hline \mathrm{t}_{\mathrm{PZL}}, \\ & \mathrm{t}_{\mathrm{PZH}} \end{aligned}$ | Output Enable Time OE to A or B | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.3 \pm 0.3 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} \end{aligned}$ |  | $\begin{gathered} \hline 8.5 \\ 11.0 \end{gathered}$ | $\begin{aligned} & 13.2 \\ & 16.7 \end{aligned}$ | $\begin{aligned} & 1.0 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & \hline 15.5 \\ & 19.0 \end{aligned}$ | ns |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=5.0 \pm 0.5 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \end{aligned}$ | $\begin{aligned} & \mathrm{C}_{\mathrm{L}}=15 \mathrm{pF} \\ & \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF} \end{aligned}$ |  | $\begin{aligned} & 5.8 \\ & 7.3 \end{aligned}$ | $\begin{gathered} \hline 8.5 \\ 10.6 \end{gathered}$ | $\begin{aligned} & 1.0 \\ & 1.0 \end{aligned}$ | $\begin{aligned} & 10.0 \\ & 12.0 \end{aligned}$ |  |
| $\begin{aligned} & \text { tpLZ, } \\ & t_{\text {PHZ }} \end{aligned}$ | Output Disable Time OE to A or B | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.3 \pm 0.3 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \end{aligned}$ | $C_{L}=50 \mathrm{pF}$ |  | 11.5 | 15.8 | 1.0 | 18.0 | ns |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=5.0 \pm 0.5 \mathrm{~V} \\ & \mathrm{R}_{\mathrm{L}}=1 \mathrm{k} \Omega \end{aligned}$ | $\mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}$ |  | 7.0 | 9.7 | 1.0 | 11.0 |  |
| tosLh, toshL | Output to Output Skew | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=3.3 \pm 0.3 \mathrm{~V} \\ & \text { (Note 1) } \end{aligned}$ | $C_{L}=50 \mathrm{pF}$ |  |  | 1.5 |  | 1.5 | ns |
|  |  | $\begin{aligned} & \mathrm{V}_{\mathrm{CC}}=5.0 \pm 0.5 \mathrm{~V} \\ & \text { (Note 1) } \end{aligned}$ | $C_{L}=50 \mathrm{pF}$ |  |  | 1.0 |  | 1.0 | ns |
| $\mathrm{C}_{\text {in }}$ | Maximum Input Capacitance DIR, OE |  |  |  | 4 | 10 |  | 10 | pF |
| $\mathrm{C}_{1 / 0}$ | Maximum Three-State I/O Capacitance |  |  |  | 8 |  |  |  | pF |


|  |  | Typical @ 25 ${ }^{\circ} \mathrm{C}, \mathrm{V}_{\mathrm{cc}}=5.0 \mathrm{~V}$ |  |
| :---: | :---: | :---: | :---: |
| $\mathrm{C}_{\text {PD }}$ | Power Dissipation Capacitance (Note 2) | 21 | pF |

1. Parameter guaranteed by design. $\mathrm{t}_{\mathrm{OSLH}}=\left|\mathrm{t}_{\mathrm{PLH}}-\mathrm{t}_{\mathrm{PLHn}}\right|, \mathrm{t}_{\mathrm{OSHL}}=\left|\mathrm{t}_{\mathrm{PHLm}}-\mathrm{t}_{\text {PHLn }}\right|$.
2. $\mathrm{C}_{P D}$ is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation: $\mathrm{I}_{\mathrm{CC}(\mathrm{OPR})}=\mathrm{C}_{\mathrm{PD}} \bullet \mathrm{V}_{\mathrm{CC}} \bullet \mathrm{f}_{\mathrm{in}}+\mathrm{I}_{\mathrm{CC}} / 8$ (per bit). $\mathrm{C}_{\mathrm{PD}}$ is used to determine the no-load dynamic power consumption; $\mathrm{P}_{\mathrm{D}}=\mathrm{C}_{\mathrm{PD}} \bullet \mathrm{V}_{\mathrm{CC}}{ }^{2} \bullet \mathrm{f}_{\mathrm{in}}+\mathrm{I}_{\mathrm{CC}} \bullet \mathrm{V}_{\mathrm{CC}}$.

NOISE CHARACTERISTICS (Input $\mathrm{t}_{\mathrm{r}}=\mathrm{t}_{\mathrm{f}}=3.0 \mathrm{~ns}, \mathrm{C}_{\mathrm{L}}=50 \mathrm{pF}, \mathrm{V}_{\mathrm{CC}}=5.0 \mathrm{~V}$ )

| Symbol | Parameter | $\mathrm{T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: |
|  |  | Typ | Max |  |
| $V_{\text {OLP }}$ | Quiet Output Maximum Dynamic $\mathrm{V}_{\text {OL }}$ | 0.9 | 1.2 | V |
| $\mathrm{V}_{\text {OLV }}$ | Quiet Output Minimum Dynamic $\mathrm{V}_{\mathrm{OL}}$ | -0.9 | -1.2 | V |
| $\mathrm{V}_{\text {IHD }}$ | Minimum High Level Dynamic Input Voltage |  | 3.5 | V |
| $V_{\text {ILD }}$ | Maximum Low Level Dynamic Input Voltage |  | 1.5 | V |

## MC74VHC245

## SWITCHING WAVEFORMS



Figure 3.

## TEST CIRCUITS


*Includes all probe and jig capacitance
Figure 5.

TEST POINT

*Includes all probe and jig capacitance

Figure 6.


Figure 7. EXPANDED LOGIC DIAGRAM


Figure 8. INPUT EQUIVALENT CIRCUIT


Figure 9. BUS TERMINAL EQUIVALENT CIRCUIT


SCALE 1：1


| Q | 0.25 （M） | T | A（S） | B（S） |
| :--- | :--- | :--- | :--- | :--- |



RECOMMENDED SOLDERING FOOTPRINT＊

＊For additional information on our Pb －Free strategy and soldering details，please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual，SOLDERRM／D．


NOTES：
1．DIMENSIONS ARE IN MILLIMETERS．
2．INTERPRET DIMENSIONS AND TOLERANCES
PER ASME Y14．5M， 1994
3．DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION
4．MAXIMUM MOLD PROTRUSION 0.15 PER SIDE
5．DIMENSION B DOES NOT INCLUDE DAMBAR
PROTRUSION．ALLOWABLE PROTRUSION
PROTRUSION．ALLOWABLE PROTRUSIO
SHALL BE 0.13 TOTAL IN EXCESS OF B
SHALL BE 0．13 TOTAL IN EXCESS OF B
DIMENSION AT MAXIMUM MATERIAL
DIMENSION AT MAXIMUM MATERIAL
CONDITION．

| DIM | MILLIMETERS |  |
| :---: | :---: | :---: |
|  | MIN | MAX |
| A | 2.35 | 2.65 |
| A1 | 0.10 | 0.25 |
| b | 0.35 | 0.49 |
| c | 0.23 | 0.32 |
| D | 12.65 | 12.95 |
| E | 7.40 | 7.60 |
| e | 1.27 BSC |  |
| H | 10.05 | 10.55 |
| h | 0.25 | 0.75 |
| L | 0.50 | 0.90 |
| 0 | $0^{\circ}$ | $7^{\circ}$ |

## GENERIC <br> MARKING DIAGRAM＊ <br> 20日月日日月日日月日 <br> 

XXXXX＝Specific Device Code
A＝Assembly Location
WL＝Wafer Lot
YY＝Year
WW＝Work Week
$\mathrm{G} \quad=\mathrm{Pb}-$ Free Package
＊This information is generic．Please refer to device data sheet for actual part marking． $\mathrm{Pb}-$ Free indicator，＂ G ＂or microdot＂$\stackrel{ }{ }$＂， may or may not be present．

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| ---: | :--- | :--- | :--- |
| DESCRIPTION： | SOIC－20 WB | PAGE 1 OF 1 |

[^0]TSSOP-20 WB
CASE 948E
ISSUE D
DATE 17 FEB 2016

SCALE 2:1


1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
CONTROLLING DIMENSION: MILLIMETER
2. DIMENSION A DOES NOT INCLUDE MOLD

FLASH, PROTRUSIONS OR GATE BURRS.
MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION INTERLEAD FLASH OR PROTRUSION. SHALL NOT EXCEED 0.25 (0.010) PER SIDE
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY
7. DIMENSION A AND B ARE TO BE DETERMINED AT DATUM PLANE -W

| DIM | MILLIMETERS |  | INCHES |  |
| :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |
| A | 6.40 | 6.60 | 0.252 | 0.260 |
| B | 4.30 | 4.50 | 0.169 | 0.177 |
| C | --- | 1.20 | --- | 0.047 |
| D | 0.05 | 0.15 | 0.002 | 0.006 |
| F | 0.50 | 0.75 | 0.020 | 0.030 |
| G | 0.65 BSC |  | 0.026 BSC |  |
| H | 0.27 | 0.3 | 0.011 | 0.015 |
| J | 0.09 | 0.20 | 0.004 | 0.008 |
| J1 | 0.09 | 0.16 | 0.004 | 0.006 |
| K | 0.19 | 0.30 | 0.007 | 0.012 |
| K1 | 0.19 | 0.25 | 0.007 | 0.010 |
| L | 6.40 BSC |  | 0.252 BSC |  |
| M | $0^{\circ}$ | $8^{\circ}$ | $0^{\circ}$ | $8^{\circ}$ |

GENERIC MARKING DIAGRAM*




A = Assembly Location
L = Wafer Lot
Y = Year
W = Work Week

- = Pb-Free Package
(Note: Microdot may be in either location)
*This information is generic. Please refer to device data sheet for actual part marking. $\mathrm{Pb}-$ Free indicator, "G" or microdot " $\quad$ ", may or may not be present.

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| ---: | :--- | :--- | :--- |
| DESCRIPTION: | TSSOP-20 WB | PAGE 1 OF 1 |

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74LCXR162245MTX 74LVXC3245MTCX 74VHC245M 74VHC245MX JM38510/65553BRA FXL2TD245L10X 74LVC1T45GM,115
74LVC245ADTR2G TC74AC245P(F) SNJ54LS245FK 74LVT245BBT20-13 74AHC245D.112 74AHCT245D. 112
SN74LVCH16952ADGGR CY74FCT16245TPVCT 74AHCT245PW. 118 74LV245DB. 118 74LV245D. 112 74LV245PW. 112
74LVC2245APW. 112 74LVCH245AD. 112 SN75138NSR AP54RHC506ELT-R AP54RHC506BLT-R 74LVCR162245ZQLR
SN74LVCR16245AZQLR MC100EP16MNR4G MC100LVEP16MNR4G 714100R 74HCT643N MC100EP16DTR2G 5962-9221403MRA
74ALVC164245PAG 74FCT16245ATPAG 74FCT16245ATPVG 74FCT16245ETPAG 74FCT245CTSOG


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